Att. Docket No. 10191/1690

HE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s)

Volker BECKER et al.

Confirmation No. 2674

Appl. Serial No.

09/762,985

Title

DEVICE AND METHOD FOR

ETCHING A SUBSTRATE USING

AN INDUCTIVELY COUPLED PLASMA

Filed

May 8, 2001

TC/A.U.

1763

Examiner

Luz L. Alejandro Mulero

Docket No.

10191 1 hereby certify that this correspondence is being deposited with the 26646 United States Postal Service with sufficient postage as first class mail

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AARON C. DEDITCH

(33,865)

RESPONSE AFTER A FINAL OFFICE ACTION

SIR:

In response to the Final Office Action mailed on August 23, 2006 (the three-month response date for which has been extended by two months from November 23, 2006 to January 23, 2007 by the accompanying Transmittal and Petition to Extend), please reconsider the above-identified application based on the following:

A Listing of the Claims is provided as a courtesy and begins on page 2 of this paper.

Remarks begin on page 9 of this paper.